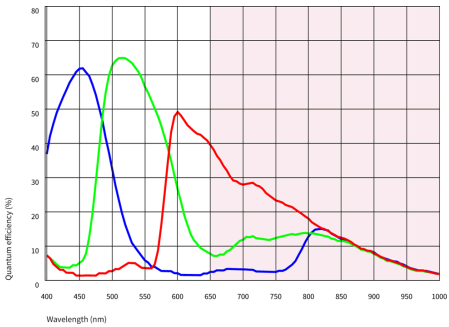


Not recommended for new designs
The camera model is no longer recommended for new application development.



Specification

Sensor	
Sensor type	CMOS Color
Shutter	Rolling shutter
Sensor characteristic	Linear
Pixel Class	12 MP
Resolution	12.33 Mpix
Resolution (h x v)	4056 x 3040 Pixel
Aspect ratio	4:3
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/2.3"
Optical Size	6.287 mm x 4.712 mm
Optical sensor diagonal	7.86 mm 1/2.3"
Pixel size	1.55 µm
CRA (Chief Ray Angle)	12 °
Manufacturer	Sony
Sensor Model	IMX412-AACK-D
Gain (master/RGB)	22.3x/15.8x
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	24 / 12
AOI image height / step width	32 / 8
AOI position grid (horizontal/vertical)	4 / 4
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	Horizontal: mean / Vertical: mean
Binning factor	2x2
Decimation (subsampling) horizontal	-
Decimation (subsampling) vertical	-
Decimation (subsampling) method	-



Model

Frame rate freerun mode	18 fps @ 10Bit
Frame rate trigger (continuous)	18 fps @ 10Bit
Frame rate trigger (maximum)	18 fps @ 10Bit
Exposure time (minimum - maximum)	0.017 ms - 1146 ms
Power consumption	0.5 W - 1 W
Image memory	-

Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.

Allowed device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Allowed ambient temperature during operation	0 °C - °C / 32 °F - 32 °F
Allowed ambient temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	USB 3.0 micro-B, screwable
I/O connector	8-pin Wuerth connector
Power supply	USB cable

Pin assignment I/O connector

1	Voltage output 3.3 V
2	Ground (GND)
3	Flash output without optocoupler - Line 1
4	Trigger input without optocoupler - Line 0
5	General Purpose I/O (GPIO) 1 - Line 2
6	General Purpose I/O (GPIO) 2 - Line 3
7	Ground (GND)
8	USB Power: 5 V, max. 400 mA



Design

Lens Mount	C-Mount
IP code	IP30
Dimensions H/W/L	29.0 mm x 29.0 mm x 17.0 mm
Mass	61 g
Housing material	Zinc nickel-plated

Features

List of on-camera image pre-processing features.

All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

Image Acquisition

Freerun	✓
Software trigger	✓
Hardware trigger	✓
Trigger controlled exposure	-
Denoiser	-
Long exposure	-
Line scan	-
Global start	-

Flashing

Flashing	-
PWM flashing	-

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Image Adjustments	Auto exposure	-
	Auto gain	-
	Auto whitebalance	-
	Color correction	-
	Gamma	-
	LUT	-
	Mirror/flip	X/Y
On-board Image Processing	Pixel formats	BayerRG10g40IDS BayerRG12g24IDS
	Region of interest	✓
	Decimation (FPGA)	-
	Decimation (Sensor)	
	Binning (FPGA)	-
	Binning (Sensor)	2x2 Increases frame rate.
Others	Chunks	-
	Sequencer	-
	Events	-
	Firmware update	✓
	1st supported firmware version	3.20